承認書

SPECIFICATION FOR APPROVA

CUSTOMER:		
CUSTOMER P/N:		
CUSTOMER PART NO:		
DESCRIPTION:	SMD INDUCTOR	
PRODUCTS NO:	BCIHP0920HC-R33M	
FIRST DATE:	2019-10-23	BC REV: X1
DATE:	2019-10-23	

PURCHASER CONFIRMED						
APPROVAL BY	CHECK BY	DRA WN BY				

REMARK			

PROVIDER ENGINEER DEPT.					
APPROVAL BY CHECK BY DRAWN BY					
ouyangweijun	xuqiuyue	chenlinli			

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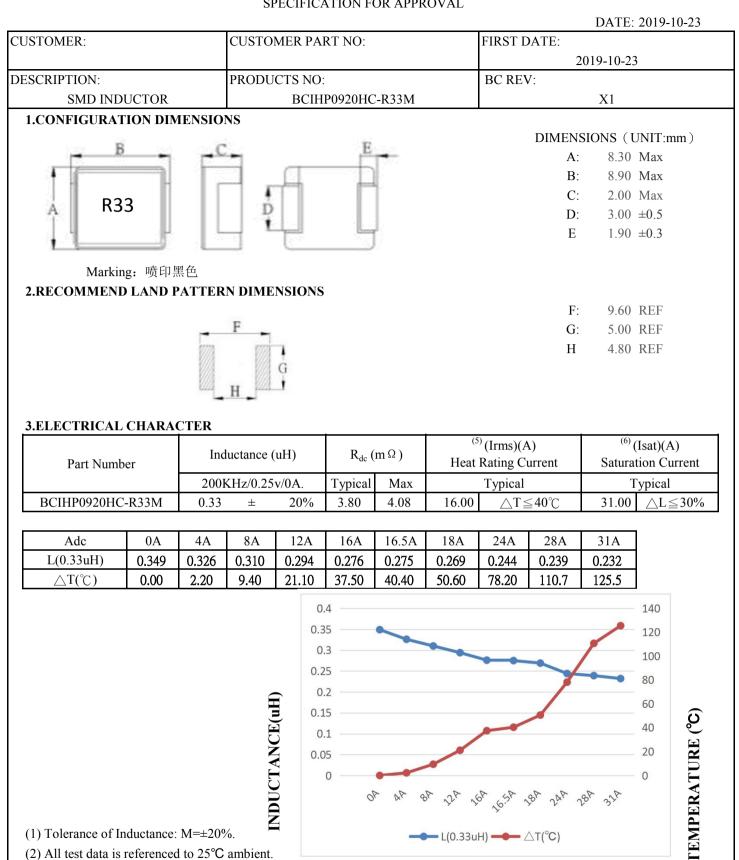
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SPECIFICATION FOR APPROVAL

ROHS Compliant



(1) Tolerance of Inductance: M=±20%.

(2) All test data is referenced to 25°C ambient.

(3) Inductance is measured at 200KHz/0.25v/0A.25°C ambient.

(4) Operating Temperature Range -40°C to +125°C.

(5) DC current (Irms) (A) that will cause an Approximate $\Delta T \leq 40^{\circ}$ C DC CURRENT (AMPS)

(6) DC current (Isat) (A) that will cause L0 to drop approximately \triangle

(7) The part Temperature (ambient + temp rise) should not exceed 125° C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling

L(0.33uH) - AT(°C)

provisions all affect the part temperature Part temperature should be verified in the end application.

[™] Irms : Heat Rating Current DC Amps.

*Isat : Saturation Current DC Amps.

ROHS Compliant

SPECIFICATION FOR APPROVAL

DATE: 2019-10-23 CUSTOMER: FIRST DATE: CUSTOMER PART NO: 2019-10-23 BC REV: DESCRIPTION: PRODUCTS NO: SMD INDUCTOR BCIHP0920HC-R33M X1 **4.PACKAGING INFORMATION** (1) Tape Dimension / Packaging Quantity **Reel Dimensions Tape Dimensions** W1 75±0 1.5dia P2=2.0±0.1 40.1/-0.0 Ĩ A:330 B:100 C:13.5 A0 Drawer direction [Direction of product] 8° MAX (Unit:mm) W2 (Unit:mm) DIMENSIONS (UNIT:mm) DIMENSIONS (UNIT:mm) A: 330.0 ±2.00 W: 24.00 ± 0.30 B: 100.0 ±0.50 A0: 8.50 ± 0.10 9.00 ± 0.10 C: 13.5 ± 0.50 B0: W1: 24.00 ±0.30 K0: 2.50 ± 0.10 W2: 29.00 ±0.50 P: 12.00 ± 0.10 Q'TY: 1,500 PCS F: 11.50 ± 0.10 T: 0.40 ± 0.05 (2) Tearing Off Force 165° to180° Top cover tape Base tape The force tearing off cover 10 to 130 grams Room Humidity Room Temp. Room atm Tearing Speed (0.1N to 1.3N) in the arrow direction (hPa) mm/min (C) (%)

under the following conditions.

•Storage conditions/Note things

5~35

(1) Storage temperature and humidity conditions :

1. Product packing with Carrier tape: $+5^{\circ}C \sim +40^{\circ}C$ and less than 60% RH.

2. Product alone: $-20^{\circ}C \sim +60^{\circ}C$ and less than 60% RH.

45~85

- (2) Products should be used within 6 months.
- (3) The packaging material should be kept where no chlorine or sulfur exists in the air.

860~1060

(4) Do not touch the electrodes (soldering terminals) with fingers as this may lead to deterioration of solder ability

300

(5) The use of tweezers or vacuum pick-ups is strongly recommended for individual components.

(6) Bulk handling should ensure that abrasion and mechanical shock are minimized.

ROHS Compliant

SAMPLE ACKNOWLEDGE CHANGE RESUME

DATE: 2019-10-23

STOMER		CUSTOMER PAR		RST DATE: 2019-1	0-23
SCRIPTI		PRODUCTS NO:		C REV:	
SN	ID INDUCTO	R BCIHF	P0920HC-R33M	X1	
DEV	i	01		M 110	
REV		Change content	Change reason	Modify	Date
X1	00	首次	首次送样	chenlinli	2019-10-23

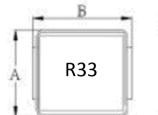
ROHS Compliant

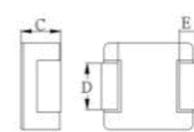
TEST DATA

DATE: 2019-10-23

CUSTOMER:	CUSTOMER PART NO:	FIRST DATE:
		2019-10-23
DESCRIPTION:	PRODUCTS NO:	BC REV:
SMD INDUCTOR	BCIHP0920HC-R33M	X1







LOT NO	LOT NO.					
DIMENS	SIONS (U	JNIT:mm)				
Α	8.30	Max				
В	8.90	Max				
С	2.00	Max				
D	3.00	±0.5				
Е	1.90	±0.3				

1Inductance (uH) $0.33 \pm 20\%$ $200KHz/0.25v/0A.$ 2Rdc (m Ω) 4.08 Max3(6) (Isat)(A)Saturation Current DC Amps $31.00 \bigtriangleup L \le 30\%$ 4(5) (Irms)(A)Heat Rating Current DC Amps $16.00 \bigtriangleup T \le 40$ °C		TEST ITEM	SPEC	TEST CONDITION
3 (6) (Isat)(A)Saturation Current DC Amps 31.00 $\triangle L \leq 30\%$	1	Inductance (uH)	$0.33 \pm 20\%$	200KHz/0.25v/0A.
	2	Rdc (mΩ)	4.08 Max	
4 (5) (Irms)(A)Heat Rating Current DC Amps $16.00 \ \triangle T \leq 40^{\circ}C$	3	(6) (Isat)(A)Saturation Current DC Amps	$31.00 riangle L \leq 30\%$	
	4	(5) (Irms)(A)Heat Rating Current DC Amps	16.00 △T≦40℃	

MEAS ITEM	Α	В	С	D	Е	1	2	3
SUGGEST	8.30	8.90	2.00	3.00	1.90	0.33	4.08	31.00
5000E51	Max	Max	Max	±0.5	±0.3	± 20%	Max	$\triangle L \leq 30\%$
1	8.20	8.53	1.89	3.00	1.90	0.33	3.65	70%
2	8.21	8.46	1.93	3.00	1.90	0.31	3.62	71%
3	8.19	8.52	1.92	3.00	1.90	0.32	3.69	71%
4	8.22	8.53	1.94	3.00	1.90	0.34	3.72	72%
5	8.21	8.49	1.93	3.00	1.90	0.33	3.76	71%
6	8.19	8.46	1.96	3.00	1.90	0.32	3.82	72%
7	8.19	8.52	1.95	3.00	1.90	0.31	3.79	71%
8	8.20	8.49	1.96	3.00	1.90	0.32	3.75	70%
9	8.23	8.52	1.95	3.00	1.90	0.33	3.81	72%
10	8.21	2.87	1.94	3.00	1.90	0.32	3.69	72%
11								
12								
13								
14								
15								
max	8.23	8.53	1.96			0.34	3.82	72.0%
min	8.19	2.87	1.89			0.31	3.62	70.0%
σ	0.013	1.690	0.020			0.009	0.064	0.007
Х	8.21	7.94	1.94			0.32	3.73	71.2%
Cpk	2.47	0.19	1.05			2.70	1.82	1349.13

2.TEST CONDITION	4.MATERIAL LIST	APPROVED BY
TEMP. 25°C R.H. 65%	CORE:	
3.TEST INSTRUMENTS		ouyangweijun
□HP-4284A METER □CH-3305 METER	WIRE:	
■HP-4285A METER □CD1068+CD1320 METER		CHECKED BY
HP-4191A METER VR113+VR712 METER		which have
CH101 LCR,METER WK3260B+WK3265B METER		xuqiuyue
VR116+VR7220 METER VR562 METER		DRAWN BY
CH-3200 METER CH-502B DCR METER		chenlinli
CH-310 METER		Chenhhh

GENERAL CHARAC	CTERISTICS page. 1			
Operation Temperature	-40°C to +125°C (Includes temperature when the coil is heated)			
External Appearance	On visual inspection, the coil has no external defects.			
	More than 90% of terminal electrode should be covered with solder.			
Solder Ability Test	1 After fluxing, component shall be dipped in a dipped in a melted. Solder:bath at $235^{\circ}C \pm 5^{\circ}C$ for 5 ± 0.5 second 150 C second 5\pm 0.5 second			
	 1.Components should have not evidence of electrical and mechanical damage. 2.Inductance: within±10% of initial value. 3.Impedance: within±10% of initial value. Preheat:150±5°C 60seconds. Solder temperature: 250±5°C. Flux: rosin. Dip time:10±0.5seconds. 			
Terminal Strength	After soldering of X,Y withstanding at below conditions .The terminal should not Peel off. (Refer to figure at below) 5N:6			
Insulating Resistance	Over $100M\Omega$ at $100V$ D.C. between coil and core.			
Dielectric Strength	No dielectric breakdown at 30V D.C. for 1 minute between coil and core.			
VibrationTest	Inductance deviation within +10% after vibration for 1 hour. In each of three orientations at sweep vibration(10-~55-~10HZ)with 1.5mmP-P amplitudes			
Drop test	Inductance deviation within +10% after being dropped once with 981m/s2 (100G) shock Attitude upon a rubber block method shock testing machine, in three different orientations			
 (2) Products should be used (3) The packaging material 2. Handling (1) Do not touch the electro 	ty of terminal electrodes: ity conditions: less than 40°C and 70% RH.			

GENERAL CHARACTE	ERISTICS	page. 2
TEST	Required Characteristics	Test Method/Condition
High Temperature StorageTest Reference documents: MIL-STD-202G Method108A	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	Temp 125°C High temperature 25°C 0°C High temperature 1H 96H Test Time Temperature: 125°C \pm 2°C Time: 96 \pm 2 hours. Tested not less than 1 hour, nor more than 2 hours at room.
Low Temperature Storage Test Reference documents: IEC 68-2-1A 6.1 6.2	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	25°C 96H Test 1H 1H 1H Time 40°C T Tested not less than 1 hour, nor more than 2 hours at room.
Humidity Test Reference documents: MIL-STD-202G Method103B	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	 40℃ 93%RH High temperature High humidity 25℃ 0℃ 1. Dry oven at a temperature of 40°C±2°C for 96hours 2. Measurements At the end of this period 3. Exposure: Temperature: 40°C±2°C. Humidity:93±2hoyrs. 4. Tested while the chamber. 5. Tested not less than 1 hour. Nor more than 2 hours at room temperature.
Thermal Shock Test Reference documents: MIL-STD-202G Method107G	 No case deformation or change in appearance △L/L≦10% △Q/Q≦30% △DCR/DCR≦10% 	First-40°C for 30 Minutes, last 125°C for 30 Minutes as 1 cycle. Go through 20 cycles.

■Application Notice/Handling

- (1) Temperature and humidity conditions : less than 40° C and 70% RH.
- (2) Products should be used within 6 months.
- (3) The packaging material should be kept where no chlorine or sulfur exists in the air.
- (4) Do not touch the electrodes (soldering terminals) with fingers as this may lead to deterioration of solder ability
- (5) The use of tweezers or vacuum pick-ups is strongly recommended for individual components.
- (6) Bulk handling should ensure that abrasion and mechanical shock are minimized.

